

HSF

TECHNICAL SPECS:

Current Rating:1.0AMP

Contact Resistance:10mΩ Max

Dielectric Strength: Min 500Vrms

Mechanical Life: Min 500 cycles

Mating Pin:Ø0.38 to Ø0.50mm

Forces: (polished steel gauge Ø0.41mm)

Insertion:150g Max/Pin, Withdrawal: 30g Min/Pin

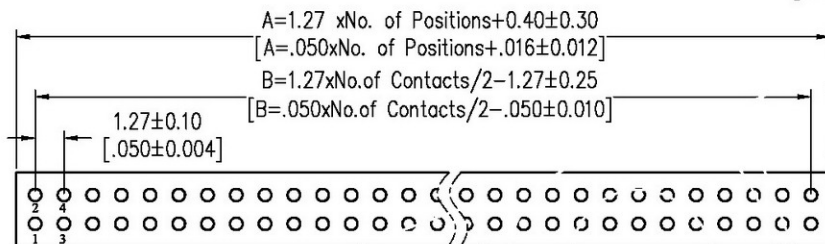
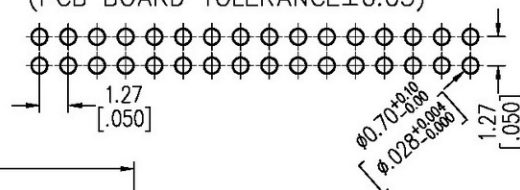
Operation Temperature:-40°C to +105°C

Sleeve: Brass CuZn36Pb3(C36000),Sn over Ni

Contact Clip(6 finger):BeCu(C17200),Au or Sn over Ni

Insulator Material: PPS+30%G.F(UL94V-0)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



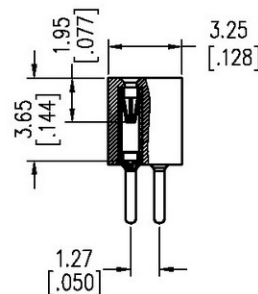
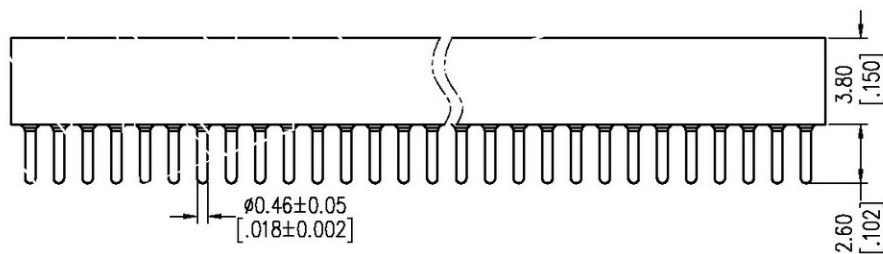
Ordering Information

3524-382 XX S XX 060 X 1

No. of Pin
2-50PIN

Contact Plating
S0=Gold Flash/Tin
S3=10u"Gold/Tin
S4=15u"Gold/Tin
S5=30u"Gold/Tin
SN=Tin

Packaging
A=Tray
T=Tube



Item	Pitch	Mating
Standard	1.27	3514
Alternate		